SIEMENS

AT&T Solid-State Relays now manufactured and marketed by **Siemens Optoelectronics Division** 19000 Homestead Road, Cupertino, CA 95014

LH1193AB/AAC High-Voltage, Solid-State Relay

Description

The LH1193AB/AAC High-Voltage, Solid-State Relay is a double-pole, single-throw, normally open switch (2 Form A) that can replace electromechanical relays in many applications. The relay features logic-level input control of isolated high-voltage switch outputs. The output is rated at 280 V and can handle loads up to 100 mA. The relay can switch both ac and dc loads and is ideal for audio frequency or dc applications. Typical ON-resistance at 50 mA is 25 Ω .

The LH1193AB/AAC Relay consists of a GaAlAs LED that optically couples control signals to a monolithic integrated circuit. Optical coupling provides 1500 Vrms of input/output isolation. The integrated circuit is a dielectrically isolated, high-voltage die comprised of photodiode arrays, switch control circuitry, and high-voltage DMOS transistor switches.

In operation, the device is exceptionally linear up to 60 mA. Beyond 60 mA, the incremental resistance decreases, thereby minimizing internal power dissipation. Overload currents are clamped at 250 mA by internal current limiting. An extended clamp condition, which increases relay temperature, results in a reduction in clamp current, thereby further reducing internal power dissipation and preserving the relay's integrity. This relay is packaged in an 8-pin, plastic DIP (LH1193AB) or in an 8-pin, surface-mount, gull-wing configuration (LH1193AAC).

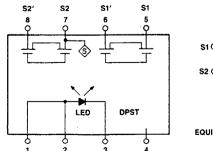
Features

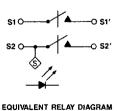
- 1500 Vrms input/output isolation
- High-surge capability
- Low ON-resistance
- Clean, bounce-free switching
- Low power consumption
- Monolithic IC reliability

Applications

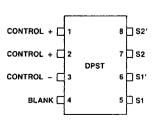
- Telephone switchhook
- High-voltage testers
- Industrial controls
- Isolation switching

Functional Diagram





Pin Diagram



Absolute Maximum Ratings

At 25 ° C

Stresses exceeding the values listed under Absolute Maximum Ratings can cause permanent damage to the device. This is an absolute stress rating only. Functional operation of the device at these or any other conditions in excess of those indicated in the operational sections of this data sheet is not implied. Exposure to maximum-rating conditions for extended periods of time can adversely affect the device reliability.

Rating	Symbol	Value	Unit
Ambient Operating Temperature Range	TA	-40 to +85	°C
Storage Temperature Range	Tstg	-40 to +100	°C
Pin Soldering Temperature (t = 7 s max.)	Ts	270	°C
Input/Output Isolation Voltage (t = 60 s min.)	Viso	1500	Vrms
LED Input Ratings:			
Continuous forward current	lF	20	mA
Reverse voltage	VR	10	V
Output Operation:			
dc or peak ac load voltage (IL \leq 50 μ A)	VL	280	V
Continuous dc load current	lL	100	mA
Power Dissipation	Poiss	600	mW

Recommended Operating Conditions

TA = 25 °C unless otherwise specified

Parameter	Symbol	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on (TA = -40 ° C to +85 ° C)	!Fon	6	10	20	mA
Continuous dc Load Current (each pole operating independently)	IL		60	150	mA
Continuous dc Load Current (each pole, two poles operating simutaneously)	ſL	_	60	100	mA

Pin Descriptions

Pin Symbol		Name/Function			
1 2	Control + Control +	These pins are the positive and negative inputs respectively to the control LED. An appropriate amount of current through the LED closes the circuit path between			
3	Control –	S and S'.			
5, 6 7, 8	S S'	These pins are the switch outputs. The pin designated as S represents one side of a relay pole. The pin designated as S is the complementary side of a relay pole. S2 is electrically connected to the device substrate. To achieve lowest dv/dt sensitivity and optimum turn-on/off performance, connect S2 to the lowest circuit potential.			
4	Blank	This pin can be used as a tie-point for external components. Voltage on this pin should not exceed 300 V.			

Characteristics

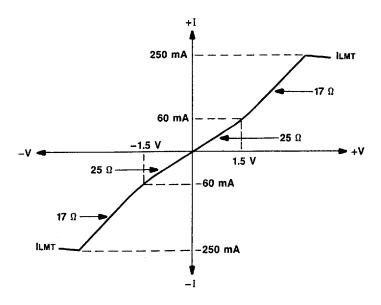


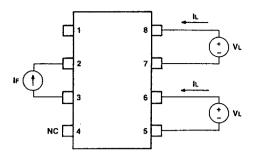
Figure 1. Typical ON Characteristics

Electrical Characteristics TA = 25°C

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

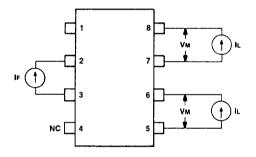
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	lFon	IL (min) = 110 mA, VL = \pm 7 V, t = 10 ms (See Figure 2.)	_	1.5	2.5	mA
LED Forward Current for Switch Turn-off	lFoff	IF = 0.2 mA, VL = ±250 V (See Figure 2.)	0.2	1.4		mA
LED Forward Voltage	VF	IF = 10 mA	1.15	1.22	1.45	٧
ON-resistance	Ron	IF = 5 mA, $IL = \pm 50$ mA (See Figure 3.)	8	25	33	Ω
Current Limit	ILMT	IF = 5 mA, VL = \pm 7 V, t = 10 ms (See Figure 4.)	220	250	350	mA
Output Off-state Leakage Current		IF = 0, VL = ±100 V (See Figure 4.)	-	0.03	200	nA
Turn-on Time	ton	IF = 5 mA, VL = $+150$ V, RL = 4 k Ω (See Figure 5.)		2.0	3.0	ms
Turn-off Time	toff	IF = 5 mA, VL = $+150$ V, RL = 4 k Ω (See Figure 5.)	_	1.5	3.0	ms
Feedthrough Capacitance Pin 5 to 6, Pin 7 to 8		IF = 0, VL = 4 Vp-p, 1 kHz		35	_	pF
Pole-to-Pole Capacitance (S1 - S2)		IF = 0 mA, f = 1 MHz		4.5	_	pF
Pole-to-Pole ON-resistance Matching (S1 - S2)		IF = 5 mA, IL = 50 mA		0.1	0.4	ΔΩ

Test Circuits



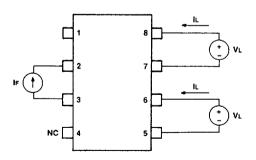
lF	VL	Measure	Parameter
2.5 mA	±7 V	L	If $ IL \ge IL$ (min), then IFon is good.
0.2 mA	±250 V	l,	If $ IL < 5 \mu A$, then IFoff is good.

Figure 2. Test Circuit for LED Forward Current for Switch Turn-On/Turn-Off



lF	lL	Measure	Parameter
5.0 mA	±50 mA	±VΜ	ON-resistance = VM 50 mA

Figure 3. Test Circuit for ON-Resistance



lF	VL	Measure	Parameter
0	±100 V	İL	Leakage = L
5.0 mA	±7 V	IL .	Current Limit = IL , t = 10 ms

Figure 4. Test Circuit for Leakage and Current Limit

Test Circuits (continued)

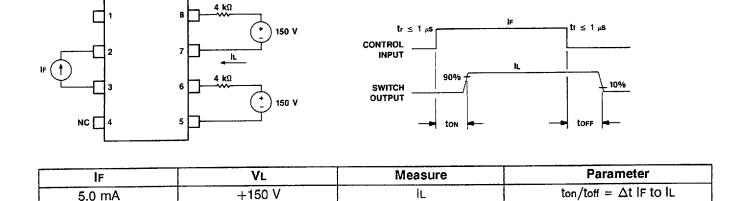


Figure 5. ton/toff Test Circuits and Waveforms

Applications

5.0 mA

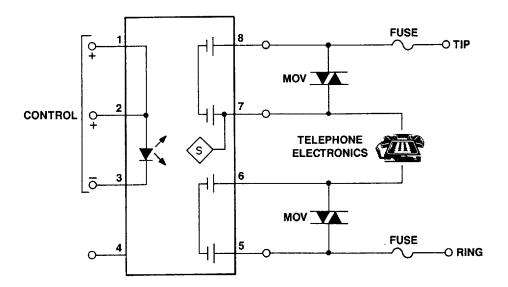
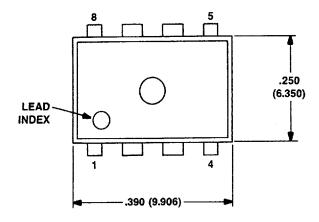


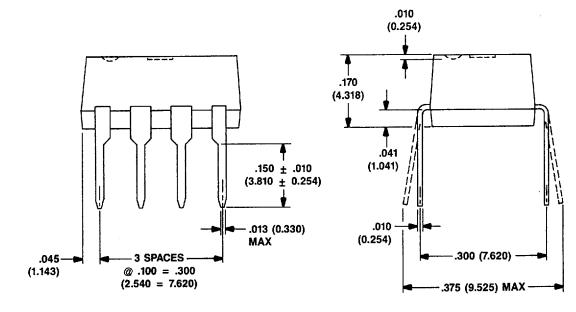
Figure 6. Balanced Switchhook Application

Outline Drawings

8-Pin, Plastic DIP (LH1193AB)

Dimensions are in inches and (millimeters).

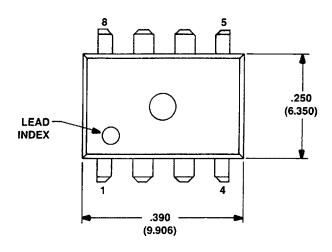


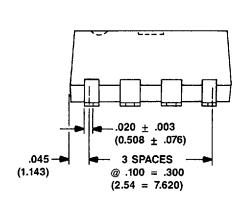


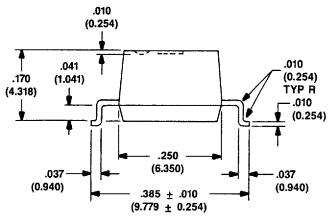
Outline Drawings (continued)

8-Pin, Plastic Gull-Wing (LH1193AAC)

Dimensions are in inches and (millimeters).







LH1193AB/AAC High-Voltage, Solid-State Relay

Ordering Information

Device	Package	Comcode		
LH1193AB	8-Pin, Plastic DIP	105486336		
LH1193AAC	8-Pin, Plastic Gull-Wing	105739171		

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□ AT&T Microelectronics AT&T Japan Ltd. 31-11, Yoyogi 1-chome Shibuya-ku, Tokyo 151 Japan Tel. (03) 5371-2700 FAX (03) 5371-3556

□ AT&T Microelectronica de España Albacete, 5 – 2^a 28027 Madrid Spain Tel. (34) 1-404 6012 FAX (34) 1-404 3469 Telex 41494 AMESP

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